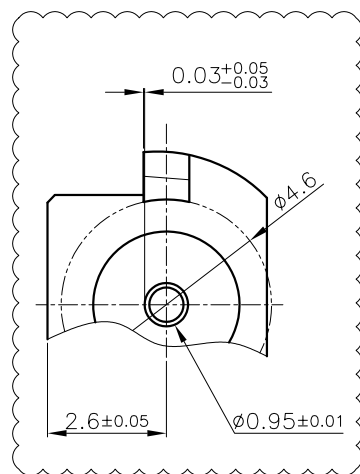
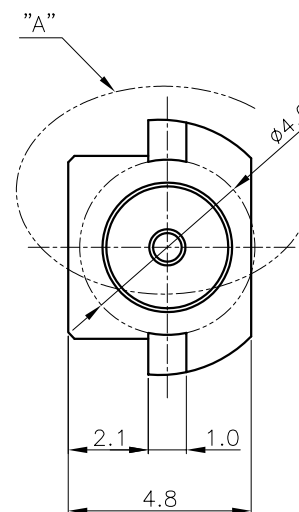
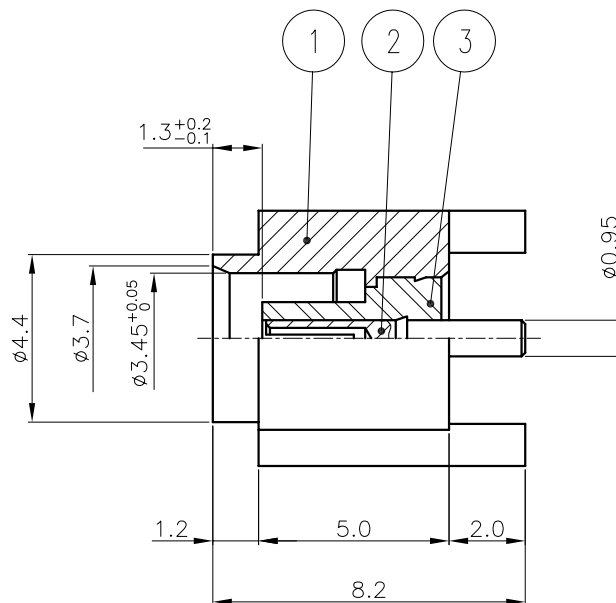
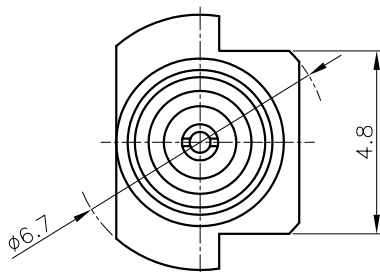


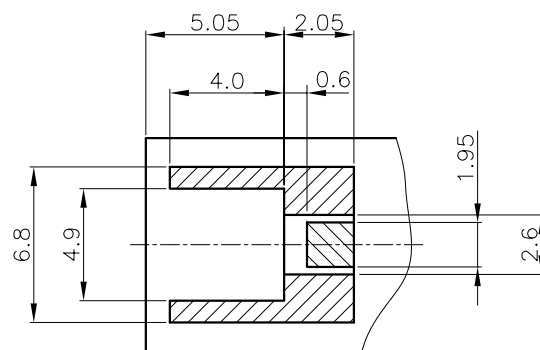
Note

* Refer to the magnification and manage the inner PIN's dimension as follow.
Managed by $\phi 0.37 \sim \phi 0.45$ Based on Center $\phi 0.4$

REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	J.H.YOUN	2011.08.12.



"A" DETAIL



RECOMMENDED
MOUNTING HOLE

3	INSULATOR	1	TEFLON		DIN01945-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT02499-5/1
1	BODY	1	MBsBD	Nickel Plate	DBD02961-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2011. 08. 12.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY J.H.YOUN			
	±1°	CHECKED BY			
MATERIAL		DRAWN BY I.C.KIM			TITLE MCX50 PCB JS-2R (edge)
FINISH		SCALE 5/1	UNIT mm		
		A4			DWG NO. CN02700-7/1
		REVISION I R			SHEET 1 of 1